

Title (en)
COMPONENT ARRANGEMENT

Title (de)
BAUELEMENTANORDNUNG

Title (fr)
MONTAGE D'UN COMPOSANT

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Application
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Abstract (en)
[origin: WO03028415A1] The invention relates to a component arrangement in which an electrical component (5) is sunk into a recess (4) of a printed circuit board (1), said electrical component (5) being fixed to an auxiliary printed circuit board (6) which, in turn, is connected to the printed circuit board (1). By sinking the electrical component (5) into the recess (4) of the printed circuit board (4), the amount by which the component projects (U) is advantageously reduced.

IPC 1-7
H05K 1/14

IPC 8 full level
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